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November 2013



FDD5N50NZ N-Channel UniFETTM II MOSFET **500 V, 4 A, 1.5** Ω

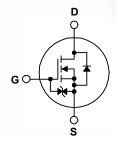
Features

- R_{DS(on)} = 1.38 Ω (Typ.) @ V_{GS} = 10 V, I_D = 2 A
- Low Gate Charge (Typ. 9 nC)
- Low C_{rss} (Typ. 4 pF)
- 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Imoroved Capability
- · RoHS Compliant

Applications

- LCD/LED/PDP TV
- Lighting
- · Uninterruptible Power Supply

Π-ΡΔΚ



Description

lasts.

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

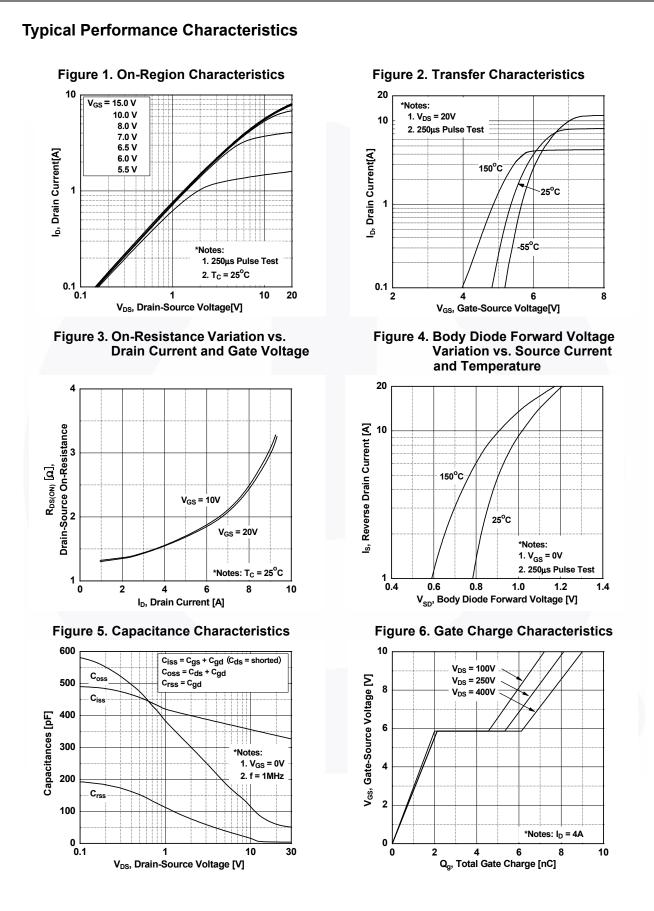
Symbol		FDD5N50NZTM	Unit		
V _{DSS}	Drain to Source Voltage		500	V	
V _{GSS}	Gate to Source Voltage		±25	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)	4		
		- Continuous (T _C = 100 ^o C)	2.4	A	
I _{DM}	Drain Current	- Pulsed (Note 1)	16	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		304	mJ	
I _{AR}	Avalanche Current (Note 1)		4	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		6.2	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		10	V/ns	
P _D	Devues Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	62	W	
	Power Dissipation	- Derate Above 25°C	0.5	W/ ^o C	
T _J , T _{STG}	Operating and Storage Tem	-55 to +150	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FDD5N50NZTM	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	90	0/00

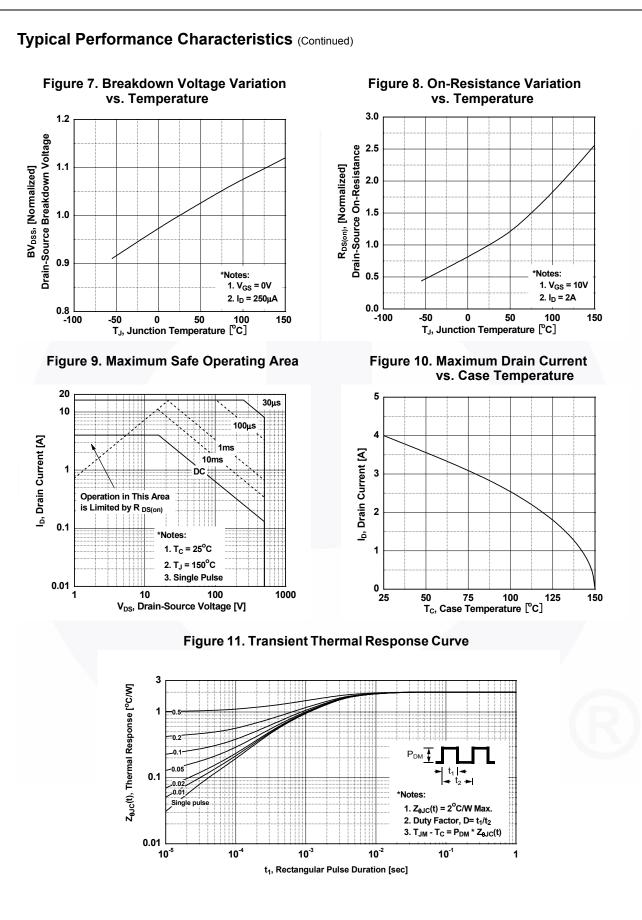
Part Nu	umber	Top Mark	Package	Packing Method	Reel Size) Ta	ape Width	Qu	antity
FDD5N5	FDD5N50NZTM FDD5N50NZ		DPAK	· · ·				2500 units	
Electrica	al Chara	acteristics T _C = 25°C u	unless other	rwise noted.					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Chara	cteristics								
BV _{DSS}	Drain to Source Breakdown Voltage		lp =	= 250 μΑ, V _{GS} = 0 V, T	- = 25°C	500	-	-	V
ΔBV_{DSS}		wn Voltage Temperature				000			
$/\Delta T_J$	Coefficier		I _D =	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.5	-	V/ºC
	Zoro Cot	Zara Cata Valtaga Drain Current		_S = 500 V, V _{GS} = 0 V		-	-	1	
IDSS	Zelu Gau	te Voltage Drain Current	V _{DS}	$_{\rm S}$ = 400 V, T _C = 125°C		-	-	10	μA
I _{GSS}	Gate to E	Body Leakage Current	V _{GS}	$_{\rm S}$ = ±25 V, V _{DS} = 0 V		-	-	±10	μA
On Chara	ctoristics								
			V	- \/ - 250 A		3.0	-	5.0	V
V _{GS(th)}		reshold Voltage		$_{\rm S} = V_{\rm DS}, I_{\rm D} = 250 \mu \text{A}$		3.0			
R _{DS(on)}		ain to Source On Resistance		$_{\rm S}$ = 10 V, I _D = 2 A		-	1.38	1.5	Ω
9 _{FS}	Forwaru	Transconductance	V DS	_S = 20 V, I _D = 2 A		-	3.54	-	S
Dynamic (Character	ristics							
C _{iss}	Input Car	pacitance		$_{\rm S} = 25 \rm V, V_{\rm GS} = 0 \rm V,$		-	330	440	pF
C _{oss}		apacitance			-	50	70	pF	
C _{rss}	'	Transfer Capacitance	T = 1	f = 1 MHz		-	4	6	pF
Q _{g(tot)}		e Charge at 10V	Var	_S = 400 V I _D = 4 A,		-	9	12	nC
Q _{gs}		Source Gate Charge		_S = 400 V I _D = 4 A, _S = 10 V			2	-	nC
Q _{gd}		Drain "Miller" Charge		5	(Note 4)	-	4	-	nC
					I		1		
Switching									
t _{d(on)}		Delay Time			L	-	12	35	ns
t _r		Rise Time		$_{\rm D} = 250 \text{ V}, \text{ I}_{\rm D} = 4 \text{ A},$	L	-	22	55	ns
t _{d(off)}		Delay Time	vGS	$_{ m S}$ = 10 V, R _G = 25 Ω	_	-	28	65	ns
t _f	Turn-Off I	Fall Time			(Note 4)	-	21	50	ns
Drain-Sou	rce Diod	e Characteristics							
I _S		Continuous Drain to Source	- Diode For	ward Current			_	4	Α
		Maximum Pulsed Drain to Source Diode Forward Current			_	_	16	A	
V _{SD}		Source Diode Forward Voltage				-	_	1.4	V
t _{rr}		Recovery Time		$S_{\rm S} = 0 \text{ V}, I_{\rm SD} = 4 \text{ A},$		-	210	-	ns
Q _{rr}		Recovery Charge		$V_{GS} = 0.0, I_{SD} = 4.4,$ $dI_{F}/dt = 100 A/\mu s$		-	1.1	-	μC

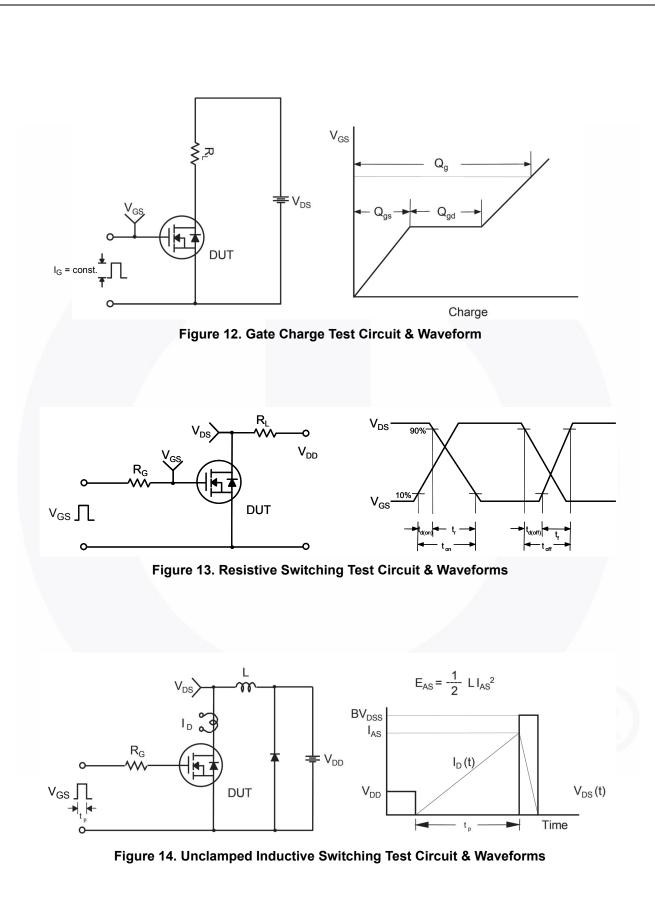
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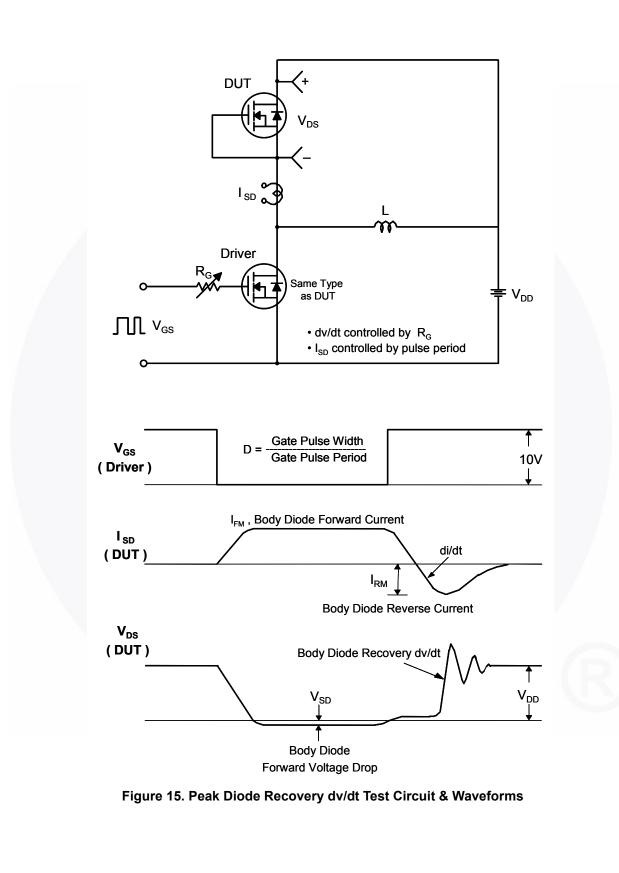


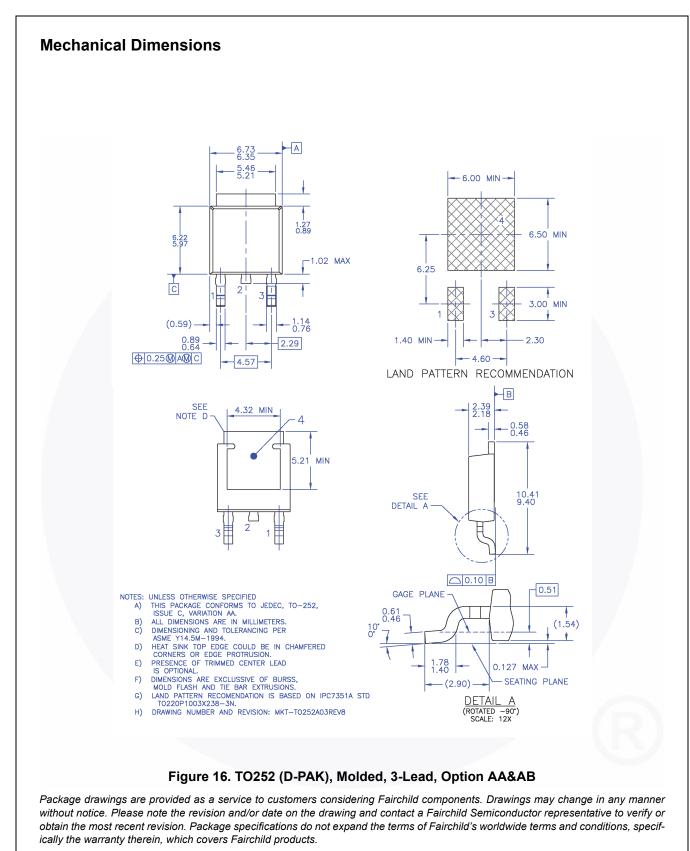
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